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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	
Peripherals	POR, WDT
Number of I/O	20
Program Memory Size	3KB (2K x 12)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	72 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.600", 15.24mm)
Supplier Device Package	28-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c57-hs-p

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

8.0 TIMER0 MODULE AND TMR0 REGISTER

The Timer0 module has the following features:

- 8-bit timer/counter register, TMR0
 - Readable and writable
- 8-bit software programmable prescaler
- · Internal or external clock select
- Edge select for external clock

Figure 8-1 is a simplified block diagram of the Timer0 module, while Figure 8-2 shows the electrical structure of the Timer0 input.

Timer mode is selected by clearing the T0CS bit (OPTION<5>). In Timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If TMR0 register is written, the increment is inhibited for the following two cycles (Figure 8-3 and Figure 8-4). The user can work around this by writing an adjusted value to the TMR0 register.



Counter mode is selected by setting the T0CS bit (OPTION<5>). In this mode, Timer0 will increment either on every rising or falling edge of pin T0CKI. The incrementing edge is determined by the source edge select bit T0SE (OPTION<4>). Clearing the T0SE bit selects the rising edge. Restrictions on the external clock input are discussed in detail in Section 8.1.

Note: The prescaler may be used by either the Timer0 module or the Watchdog Timer, but not both.

The prescaler assignment is controlled in software by the control bit PSA (OPTION<3>). Clearing the PSA bit will assign the prescaler to Timer0. The prescaler is not readable or writable. When the prescaler is assigned to the Timer0 module, prescale values of 1:2, 1:4,..., 1:256 are selectable. Section 8.2 details the operation of the prescaler.

A summary of registers associated with the Timer0 module is found in Table 8-1.



FIGURE 8-2: ELECTRICAL STRUCTURE OF TOCKI PIN



8.1 Using Timer0 with an External Clock

When an external clock input is used for Timer0, it must meet certain requirements. The external clock requirement is due to internal phase clock (Tosc) synchronization. Also, there is a delay in the actual incrementing of Timer0 after synchronization.

8.1.1 EXTERNAL CLOCK SYNCHRONIZATION

When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of T0CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 8-5). Therefore, it is necessary for T0CKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device. When a prescaler is used, the external clock input is divided by the asynchronous ripple counter-type prescaler so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple counter must be taken into account. Therefore, it is necessary for TOCKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on TOCKI high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

8.1.2 TIMER0 INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the Timer0 module is actually incremented. Figure 8-5 shows the delay from the external clock edge to the timer incrementing.



Belay from clock input change to Timer0 increment is 3 lose to 7 lose (duration of Q = lose). There the error in measuring the interval between two edges on Timer0 input = ± 4 Tose max.

9.0 SPECIAL FEATURES OF THE CPU

What sets a microcontroller apart from other processors are special circuits that deal with the needs of realtime applications. The PIC16C5X family of microcontrollers have a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These features are:

- Oscillator Selection (Section 4.0)
- RESET (Section 5.0)
- Power-On Reset (Section 5.1)
- Device Reset Timer (Section 5.2)
- Watchdog Timer (WDT) (Section 9.2)
- SLEEP (Section 9.3)
- Code protection (Section 9.4)
- ID locations (Section 9.5)

The PIC16C5X Family has a Watchdog Timer which can be shut off only through configuration bit WDTE. It runs off of its own RC oscillator for added reliability. There is an 18 ms delay provided by the Device Reset Timer (DRT), intended to keep the chip in RESET until the crystal oscillator is stable. With this timer on-chip, most applications need no external RESET circuitry.

The SLEEP mode is designed to offer a very low current Power-down mode. The user can wake up from SLEEP through external RESET or through a Watchdog Timer time-out. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost while the LP crystal option saves power. A set of configuration bits are used to select various options.

10.0 INSTRUCTION SET SUMMARY

Each PIC16C5X instruction is a 12-bit word divided into an OPCODE, which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16C5X instruction set summary in Table 10-2 groups the instructions into byte-oriented, bit-oriented, and literal and control operations. Table 10-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator is used to specify which one of the 32 file registers in that bank is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an 8 or 9-bit constant or literal value.

TABLE 10-1:	OPCODE FIELD
	DESCRIPTIONS

DESCRIPTIONS							
Field	Description						
f	Register file address (0x00 to 0x1F)						
W	Working register (accumulator)						
b	Bit address within an 8-bit file register						
k	Literal field, constant data or label						
x	 Don't care location (= 0 or 1) The assembler will generate code with x = 0. It is the recommended form of use for com- 						
	patibility with all Microchip software tools.						
d	Destination select; d = 0 (store result in W) d = 1 (store result in file register 'f') Default is d = 1						
label	Label name						
TOS	Top of Stack						
PC	Program Counter						
WDT	Watchdog Timer Counter						
TO	Time-out bit						
PD	Power-down bit						
dest	Destination, either the W register or the specified register file location						
[]	Options						
()	Contents						
\rightarrow	Assigned to						
< >	Register bit field						
∈	In the set of						
italics	User defined term (font is courier)						

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time would be 1 μ s. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time would be 2 μ s.

Figure 10-1 shows the three general formats that the instructions can have. All examples in the figure use the following format to represent a hexadecimal number:

0xhhh

where 'h' signifies a hexadecimal digit.

FIGURE 10-1: GENERAL FORMAT FOR INSTRUCTIONS

Byte-oriented file register operations								
<u>11 6</u>	5	4 0						
OPCODE	d	f (FILE #)						
d = 1 for destination	d = 0 for destination W d = 1 for destination f f = 5-bit file register address							
Bit-oriented file registe	r ope	erations						
11 8	7	5 4 0						
OPCODE	b (Bl	IT #) f (FILE #)						
f = 5-bit file regist	eratio	ons (except GOTO)						
11	8	7 0						
OPCODE		k (literal)						
k = 8-bit immedia	k = 8-bit immediate value							
Literal and control operations - GOTO instruction								
11	9	8 0						
OPCODE		k (literal)						
k = 9-bit immediate value								

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XORLW	eral with	w			
Syntax:	[label]	XORLW	k		
Operands:	$0 \le k \le 2$	55			
Operation:	(W) .XOF	$R. k \to (W$	/)		
Status Affected:	Z				
Encoding:	1111	kkkk	kkkk		
Description: The contents of the W register XOR'ed with the eight bit literal The result is placed in the W re ter.					
Words:	1				
Cycles:	1				
Example:	XORLW	0xAF			
Before Instru W = After Instruct W =					

Exclusive OR W with f	
[label] XORWF f,d	-
$\begin{array}{l} 0 \leq f \leq 31 \\ d \in [0,1] \end{array}$	
(W) .XOR. (f) \rightarrow (dest)	
ted: Z	
0001 10df ffff	
W register with register 'f'. If 'd' is 0 the result is stored in the W regis- ter. If 'd' is 1 the result is stored back in register 'f'.	
1	
1	
XORWF REG,1	
Instruction G = 0xAF = 0xB5 struction G = 0x1A = 0xB5	
the result is stored in t ter. If 'd' is 1 the result back in register 'f'. 1 1 XORWF REG, 1 nstruction G = 0xAF = 0xB5 struction	er 'f'. If 'd' is 0 the W regis-

11.13 PICDEM 3 Low Cost PIC16CXXX Demonstration Board

The PICDEM 3 demonstration board is a simple demonstration board that supports the PIC16C923 and PIC16C924 in the PLCC package. It will also support future 44-pin PLCC microcontrollers with an LCD Module. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM 3 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer with an adapter socket, and easily test firmware. The MPLAB ICE in-circuit emulator may also be used with the PICDEM 3 demonstration board to test firmware. A prototype area has been provided to the user for adding hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push button switches, a potentiometer for simulated analog input, a thermistor and separate headers for connection to an external LCD module and a keypad. Also provided on the PICDEM 3 demonstration board is a LCD panel, with 4 commons and 12 segments, that is capable of displaying time, temperature and day of the week. The PICDEM 3 demonstration board provides an additional RS-232 interface and Windows software for showing the demultiplexed LCD signals on a PC. A simple serial interface allows the user to construct a hardware demultiplexer for the LCD signals.

11.14 PICDEM 17 Demonstration Board

The PICDEM 17 demonstration board is an evaluation board that demonstrates the capabilities of several Microchip microcontrollers, including PIC17C752, PIC17C756A, PIC17C762 and PIC17C766. All necessary hardware is included to run basic demo programs, which are supplied on a 3.5-inch disk. A programmed sample is included and the user may erase it and program it with the other sample programs using the PRO MATE II device programmer, or the PICSTART Plus development programmer, and easily debug and test the sample code. In addition, the PICDEM 17 demonstration board supports downloading of programs to and executing out of external FLASH memory on board. The PICDEM 17 demonstration board is also usable with the MPLAB ICE in-circuit emulator, or the PICMASTER emulator and all of the sample programs can be run and modified using either emulator. Additionally, a generous prototype area is available for user hardware.

11.15 KEELOQ Evaluation and Programming Tools

KEELOQ evaluation and programming tools support Microchip's HCS Secure Data Products. The HCS evaluation kit includes a LCD display to show changing codes, a decoder to decode transmissions and a programming interface to program test transmitters.

12.5 DC Characteristics: PIC16C54/55/56/57-RCE, XTE, 10E, HSE, LPE (Extended)

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise specified)Operating Temperature $-40^{\circ}C \le TA \le +125^{\circ}C$ for extended						
Param No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions		
D030	VIL	Input Low Voltage							
		I/O ports	Vss	—	0.15 Vdd	V	Pin at hi-impedance		
		MCLR (Schmitt Trigger)	Vss	—	0.15 Vdd	V	-		
		T0CKI (Schmitt Trigger)	Vss	_	0.15 VDD	V			
		OSC1 (Schmitt Trigger)	Vss	_	0.15 VDD	V	PIC16C5X-RC only ⁽³⁾		
		OSC1 (Schmitt Trigger)	Vss	—	0.3 Vdd	V	PIC16C5X-XT, 10, HS, LP		
D040	Vih	Input High Voltage							
		I/O ports	0.45 Vdd		Vdd	V	For all VDD ⁽⁴⁾		
		I/O ports	2.0	—	Vdd	V	$4.0V < VDD \le 5.5V^{(4)}$		
		I/O ports	0.36 VDD	—	Vdd	V	VDD > 5.5 V		
		MCLR (Schmitt Trigger)	0.85 Vdd	_	Vdd	V			
		T0CKI (Schmitt Trigger)	0.85 Vdd	_	Vdd	V			
		OSC1 (Schmitt Trigger)	0.85 Vdd	_	Vdd	V	PIC16C5X-RC only ⁽³⁾		
		OSC1 (Schmitt Trigger)	0.7 Vdd	—	Vdd	V	PIC16C5X-XT, 10, HS, LP		
D050	VHYS	Hysteresis of Schmitt Trigger inputs	0.15 Vdd*	_	—	V			
D060	lı∟	Input Leakage Current (1,2)					For V DD ≤ 5.5 V :		
		I/O ports	-1	0.5	+1	μA	VSS \leq VPIN \leq VDD, pin at hi-impedance		
		MCLR	-5	_	_	μA	VPIN = VSS + 0.25V		
		MCLR	_	0.5	+5	μA	VPIN = VDD		
		тоскі	-3	0.5	+3	μA	$VSS \leq VPIN \leq VDD$		
		OSC1	-3	0.5	+3	μA	$VSS \le VPIN \le VDD$, PIC16C5X-XT, 10, HS, LP		
D080	Vol	Output Low Voltage							
		I/O ports OSC2/CLKOUT	—	_	0.6 0.6	V V	IOL = 8.7 mA, VDD = 4.5V IOL = 1.6 mA, VDD = 4.5V, PIC16C5X-RC		
D090	Vон	Output High Voltage⁽²⁾ I/O ports OSC2/CLKOUT	Vdd – 0.7 Vdd – 0.7			V V	IOH = -5.4 mA, VDD = 4.5V IOH = -1.0 mA, VDD = 4.5V, PIC16C5X-RC		

† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

Note 1: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.

2: Negative current is defined as coming out of the pin.

3: For PIC16C5X-RC devices, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.

4: The user may use the better of the two specifications.

13.1 DC Characteristics: PIC16CR54A-04, 10, 20, PIC16LCR54A-04 (Commercial) PIC16CR54A-04I, 10I, 20I, PIC16LCR54A-04I (Industrial)

	R54A-04 R54A-04I ercial, Indus	trial)	$ \begin{array}{ l l l l l l l l l l l l l l l l l l l$						
PIC16CR54A-04, 10, 20 PIC16CR54A-04I, 10I, 20I (Commercial, Industrial)				$\begin{array}{ll} \mbox{Standard Operating Conditions (unless otherwise specified)} \\ \mbox{Operating Temperature} & 0^{\circ}C \leq TA \leq +70^{\circ}C \mbox{ for commercial} \\ -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for industrial} \end{array}$					
Param No.	Symbol Characteristic/Device Min Typt Max Units						Conditions		
	Vdd	Supply Voltage							
D001		PIC16LCR54A	2.0		6.25	V			
D001 D001A		PIC16CR54A	2.5 4.5	_	6.25 5.5	V V	RC and XT modes HS mode		
D002	Vdr	RAM Data Retention Voltage ⁽¹⁾	_	1.5*	_	V	Device in SLEEP mode		
D003	VPOR	VDD Start Voltage to ensure Power-on Reset	—	Vss	—	V	See Section 5.1 for details on Power-on Reset		
D004	SVDD	VDD Rise Rate to ensure Power-on Reset	0.05*	_	—	V/ms	See Section 5.1 for details on Power-on Reset		
	Idd	Supply Current ⁽²⁾							
D005		PICLCR54A	_	10	20 70	μΑ μΑ	Fosc = 32 kHz, VDD = 2.0V Fosc = 32 kHz, VDD = 6.0V		
D005A		PIC16CR54A		2.0 0.8 90	3.6 1.8 350	mA mA μA	RC⁽³⁾ and XT modes: Fosc = 4.0 MHz, VDD = 6.0V Fosc = 4.0 MHz, VDD = 3.0V Fosc = 200 kHz, VDD = 2.5V HS mode:		
				4.8 9.0	10 20	mA mA	Fosc = 10 MHz, VDD = 5.5V Fosc = 20 MHz, VDD = 5.5V		

Legend: Rows with standard voltage device data only are shaded for improved readability.

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

- 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.
 - a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, T0CKI = VDD, MCLR = VDD; WDT enabled/ disabled as specified.
 - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.
- **3:** Does not include current through REXT. The current through the resistor can be estimated by the formula: IR = VDD/2REXT (mA) with REXT in k Ω .

13.6 Timing Diagrams and Specifications



FIGURE 13-2: EXTERNAL CLOCK TIMING - PIC16CR54A

TABLE 13-1: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16CR54A

AC Chara	cteristics	Standard Operating Conditions (unless otherwise specified)Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ for commercial $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for extended					-	
Param No.	Symbol	Characteristic	Min Typ†		Max	Units	Conditions	
	Fosc	External CLKIN Frequency ⁽¹⁾	DC	_	4.0	MHz	XT OSC mode	
			DC	—	4.0	MHz	HS osc mode (04)	
			DC	_	10	MHz	HS osc mode (10)	
			DC	—	20	MHz	HS osc mode (20)	
			DC	_	200	kHz	LP osc mode	
		Oscillator Frequency ⁽¹⁾	DC		4.0	MHz	RC OSC mode	
			0.1	_	4.0	MHz	XT osc mode	
			4.0	_	4.0	MHz	HS osc mode (04)	
			4.0	_	10	MHz	HS osc mode (10)	
			4.0	_	20	MHz	HS osc mode (20)	
			5.0	—	200	kHz	LP osc mode	

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

Note 1: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

2: Instruction cycle period (TCY) equals four times the input oscillator time base period.

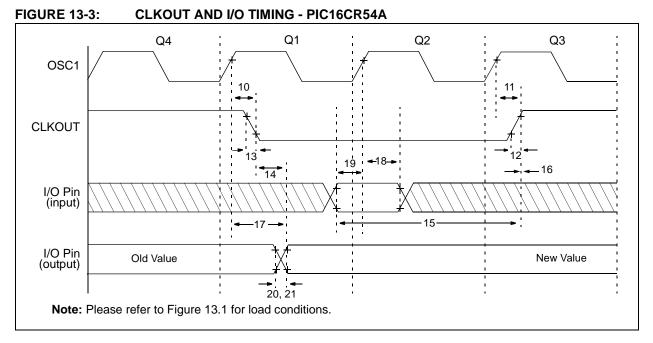


TABLE 13-2: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16CR54A

AC Chara	acteristics	$\begin{array}{ll} \mbox{Standard Operating Conditions (unless otherwise specified)} \\ \mbox{Operating Temperature} & 0^{\circ}C \leq TA \leq +70^{\circ}C \mbox{ for commercial} \\ -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for industrial} \\ -40^{\circ}C \leq TA \leq +125^{\circ}C \mbox{ for extended} \end{array}$						
Param No.	Symbol	Characteristic	Min	Тур†	Max	Units		
10	TosH2ckL	OSC1↑ to CLKOUT↓ ⁽¹⁾	—	15	30**	ns		
11	TosH2ckH	OSC1↑ to CLKOUT↑ ⁽¹⁾	—	15	30**	ns		
12	TckR	CLKOUT rise time ⁽¹⁾	—	5.0	15**	ns		
13	TckF	CLKOUT fall time ⁽¹⁾	—	5.0	15**	ns		
14	TckL2ioV	CLKOUT↓ to Port out valid ⁽¹⁾	—	—	40**	ns		
15	TioV2ckH	Port in valid before CLKOUT ⁽¹⁾	0.25 TCY+30*	—		ns		
16	TckH2iol	Port in hold after CLKOUT ⁽¹⁾	0*	—		ns		
17	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid ⁽²⁾	—	—	100*	ns		
18	TosH2iol	OSC1 [↑] (Q2 cycle) to Port input invalid (I/O in hold time)	TBD	—	—	ns		
19	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	TBD	—	—	ns		
20	TioR	Port output rise time ⁽²⁾	_	10	25**	ns		
21	TioF	Port output fall time ⁽²⁾	_	10	25**	ns		

* These parameters are characterized but not tested.

- ** These parameters are design targets and are not tested. No characterization data available at this time.
- † Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

2: Please refer to Figure 13.1 for load conditions.



FIGURE 14-5: TYPICAL IPD vs. VDD, WATCHDOG DISABLED

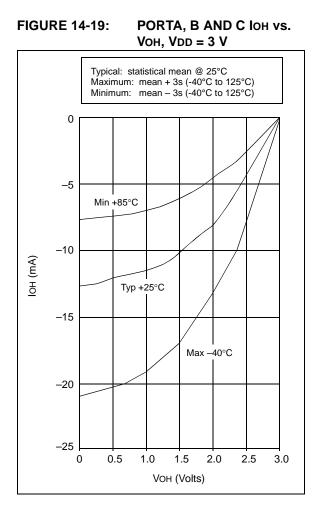


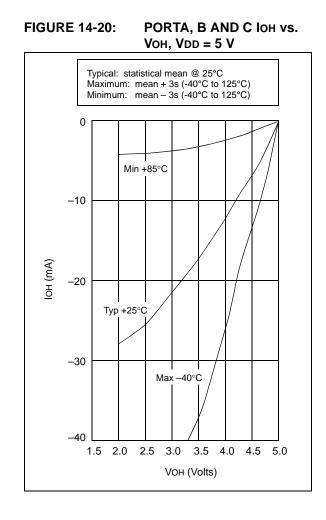












15.2 DC Characteristics: PIC16C54A-04E, 10E, 20E (Extended) PIC16LC54A-04E (Extended)

		FICTULCJ			cnac	ч)	
PIC16LC54A-04E (Extended)				ard Ope ting Terr			tions (unless otherwise specified) $-40^{\circ}C \le TA \le +125^{\circ}C$ for extended
PIC16C54A-04E, 10E, 20E (Extended)				ard Ope ting Terr			tions (unless otherwise specified) $-40^{\circ}C \le TA \le +125^{\circ}C$ for extended
Param No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions
	Vdd	Supply Voltage			•		
D001		PIC16LC54A	3.0 2.5	_	6.25 6.25	V V	XT and RC modes LP mode
D001A		PIC16C54A	3.5 4.5		5.5 5.5	V V	RC and XT modes HS mode
D002	Vdr	RAM Data Retention Voltage ⁽¹⁾	—	1.5*	-	V	Device in SLEEP mode
D003	VPOR	VDD Start Voltage to ensure Power-on Reset	—	Vss	-	V	See Section 5.1 for details on Power-on Reset
D004	Svdd	VDD Rise Rate to ensure Power-on Reset	0.05*	_	_	V/ms	See Section 5.1 for details on Power-on Reset
	IDD	Supply Current ⁽²⁾					
D010		PIC16LC54A	—	0.5	25	mA	Fosc = 4.0 MHz, VDD = 5.5V, RC ⁽³⁾ and XT modes
			—	11	27	μA	Fosc = 32 kHz, VDD = 2.5V, LP mode, Commercial
			—	11	35	μA	Fosc = 32 kHz, VDD = 2.5V, LP mode, Industrial
			_	11	37	μA	Fosc = 32 kHz, VDD = 2.5V, LP mode, Extended
D010A		PIC16C54A	—	1.8	3.3	mA	Fosc = 4.0 MHz, VDD = 5.5V, $RC^{(3)}$ and XT modes
			—	4.8	10	mA	Fosc = 10 MHz, VDD = 5.5V, HS mode
			—	9.0	20	mA	Fosc = 20 MHz, VDD = 5.5V, HS mode

Legend: Rows with standard voltage device data only are shaded for improved readability.

- * These parameters are characterized but not tested.
- † Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
- Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.
 - a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/ disabled as specified.
 - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.
 - **3:** Does not include current through REXT. The current through the resistor can be estimated by the formula: IR = VDD/2REXT (mA) with REXT in kΩ.



FIGURE 16-9: VIH, VIL OF MCLR, TOCKI AND OSC1 (IN RC MODE) vs. VDD

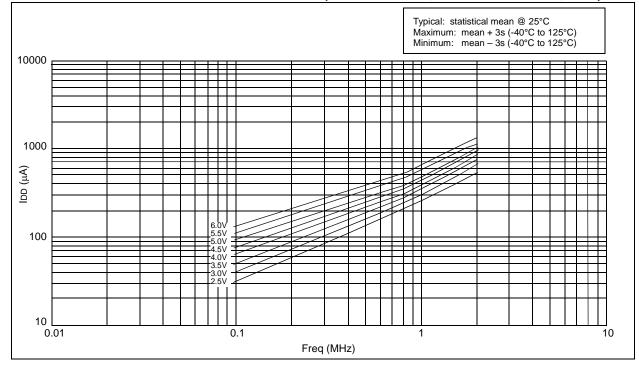
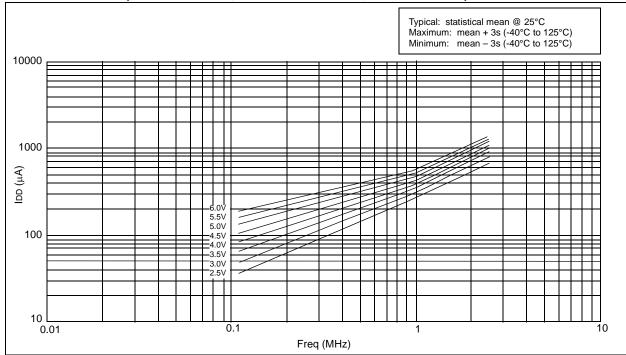


FIGURE 16-12: TYPICAL IDD vs. FREQUENCY (WDT DISABLED, RC MODE @ 100 PF, 25°C)

FIGURE 16-13: MAXIMUM IDD vs. FREQUENCY (WDT DISABLED, RC MODE @ 100 PF, -40°C to +85°C)



 Typical: statistical mean @ 25°C.

 Maximum: mean + 3s (-40°C to 125°C)

 Minimum: mean - 3s (-40°C to 125°C)
 </tr

FIGURE 16-14: TYPICAL IDD vs. FREQUENCY (WDT DISABLED, RC MODE @ 300 PF, 25°C)

FIGURE 16-15: MAXIMUM IDD vs. FREQUENCY (WDT DISABLED, RC MODE @ 300 PF, -40°C to +85°C)

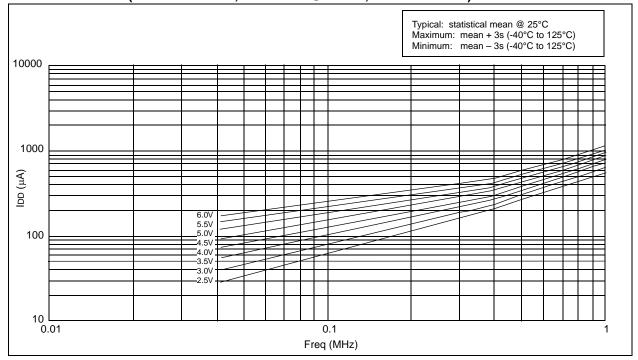


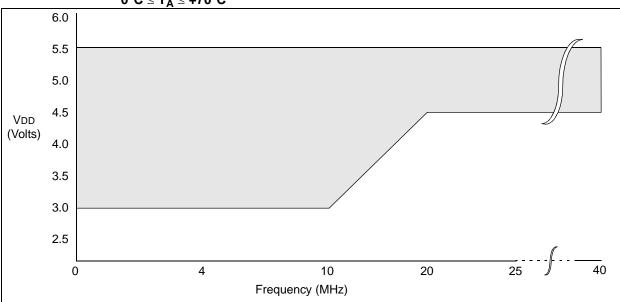


FIGURE 18-12: TYPICAL IDD vs. FREQUENCY (WDT DISABLED, RC MODE @ 100 PF, 25°C)





FIGURE 19-1: PIC16C54C/C55A/C56A/C57C/C58B-40 VOLTAGE-FREQUENCY GRAPH, $0^{\circ}C \le T_A \le +70^{\circ}C$





- **2:** The maximum rated speed of the part limits the permissible combinations of voltage and frequency. Please reference the Product Identification System section for the maximum rated speed of the parts.
- **3:** Operation between 20 to 40 MHz requires the following:
 - VDD between 4.5V. and 5.5V
 - OSC1 externally driven
 - OSC2 not connected
 - HS mode
 - Commercial temperatures

Devices qualified for 40 MHz operation have -40 designation (ex: PIC16C54C-40/P).

4: For operation between DC and 20 MHz, see Section 17.1.

19.1 DC Characteristics:PIC16C54C/C55A/C56A/C57C/C58B-40 (Commercial)⁽¹⁾

PIC16C54C/C55A/C56A/C57C/C58B-40 (Commercial)							tions (unless otherwise specified) $0^{\circ}C \le TA \le +70^{\circ}C$ for commercial
Param No.	Symbol	Characteristic	Min	Min Typ† Max Units		Units	Conditions
D001	Vdd	Supply Voltage	4.5	-	5.5	V	HS mode from 20 - 40 MHz
D002	Vdr	RAM Data Retention Voltage ⁽²⁾		1.5*	—	V	Device in SLEEP mode
D003	VPOR	VDD Start Voltage to ensure Power-on Reset	—	Vss	—	V	See Section 5.1 for details on Power-on Reset
D004	SVDD	VDD Rise Rate to ensure Power- on Reset	0.05*	_	—	V/ms	See Section 5.1 for details on Power-on Reset
D010	Idd	Supply Current ⁽³⁾	_	5.2 6.8	12.3 16	mA mA	Fosc = 40 MHz, VDD = 4.5V, HS mode Fosc = 40 MHz, VDD = 5.5V, HS mode
D020	IPD	Power-down Current ⁽³⁾	_	1.8 9.8	7.0 27*	μΑ μΑ	VDD = 5.5V, WDT disabled, Commercial VDD = 5.5V, WDT enabled, Commercial

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

- **Note 1:** Device operation between 20 MHz to 40 MHz requires the following: VDD between 4.5V to 5.5V, OSC1 pin externally driven, OSC2 pin not connected, HS oscillator mode and commercial temperatures. For operation between DC and 20 MHz, See Section 19.1.
 - **2:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
 - **3:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.
 - a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
 - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.